









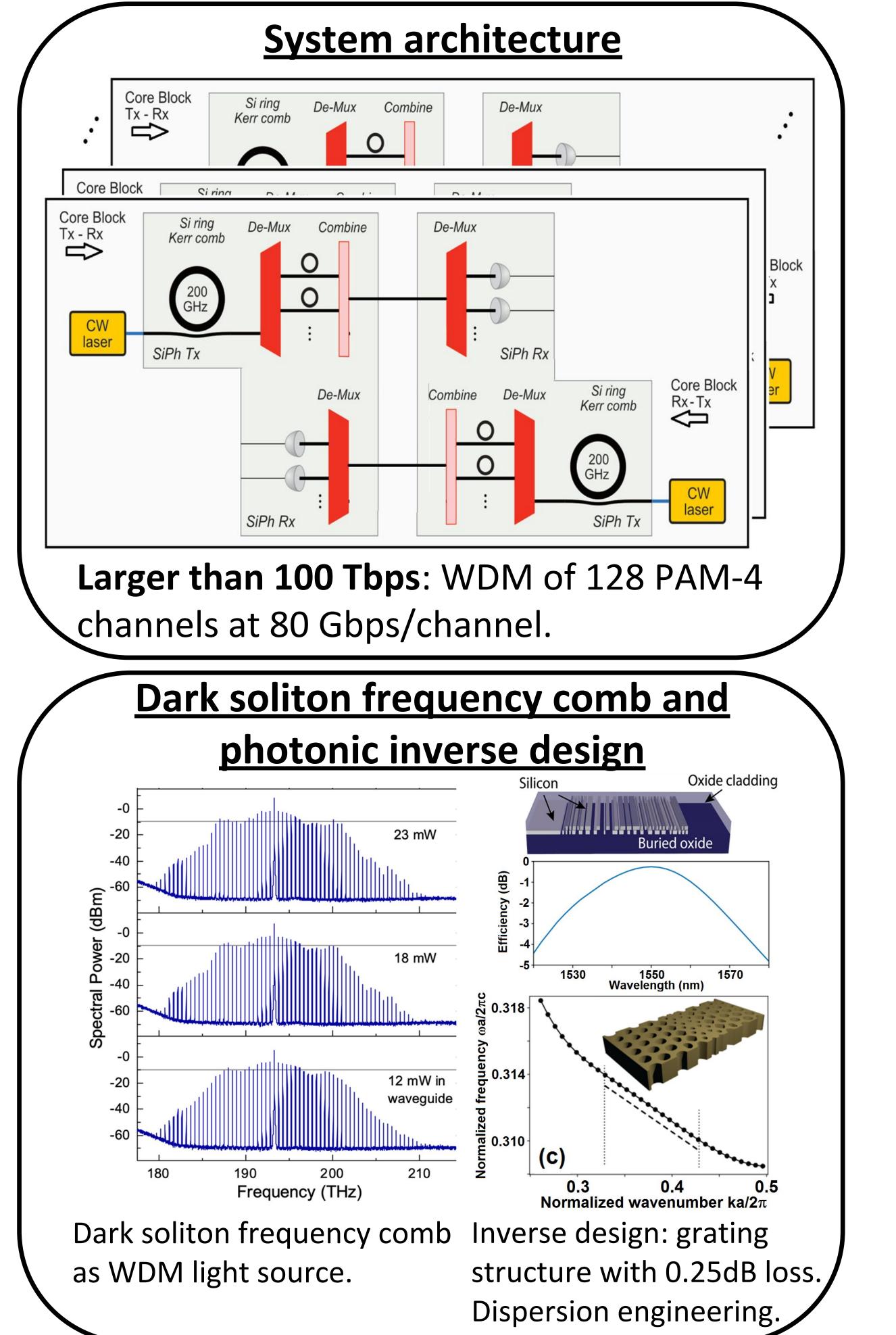
Towards Peta-bit/s Optical Links

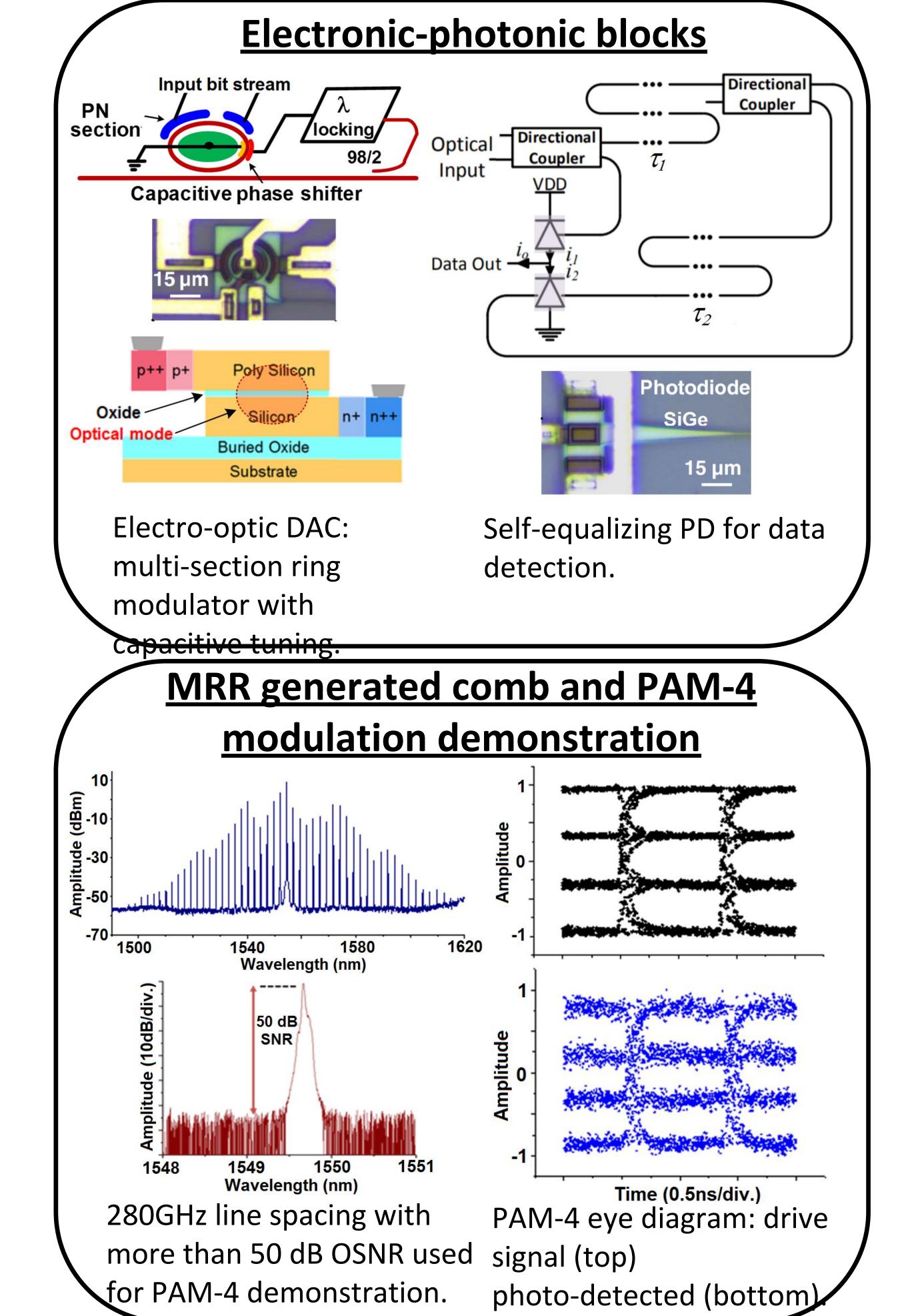
Farshid Ashtiani^{1,*}, Su-Peng Yu^{2,*}, Geun Ho Ahn^{3,*}, Jinhie Skarda^{3,*}, Logan Su^{3,*}, Dries Vercruysse^{3,*}, Ki Youl Yang^{3,*}, Chinmay Shirpurkar^{4,*}, Peter Delfyett⁴, Jelena Vuckovic², Scott B. Papp², and Firooz Aflatouni^{1,†} ¹University of Pennsylvania, ²University of Colorado Boulder, ³Stanford University, ⁴University of Central Florida [†]firooz@seas.upenn.edu, *These authors contributed equally to this work.

Introduction

- At high data-rates, low-power chip-to-chip and board-to-board communication using electrical interconnects is challenging.
- Innovative optical interconnects can address these challenges:
 - Advance integrated photonic devices offer large available bandwidth, low propagation loss, Immunity to electromagnetic interference
 - *C* Kerr microresonator frequency combs offer compact solution for high quality WDM light source
 - Inverse design can be used to significantly improve the loss, bandwidth, and chip area

<u>Comb-enabled monolithic electronic-photonic massive link architecture</u>







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